



Film Capacitors

Metallized Polypropylene Film Capacitors (MKP)

Series/Type: B32612 ... B32614

Date: May 2009

High pulse (wound)

Typical applications

- Electronic ballasts
- Switch-mode power supplies

Climatic

- Max. operating temperature: 110 °C
- Climatic category (IEC 60068-1): 55/100/56

Construction

- Dielectric: polypropylene (PP)
- Wound capacitor technology
- Epoxy resin coating (UL 94 V-0)

Features

- Very high pulse strength

Terminals

- Crimped wire leads, lead-free tinned, lead length (6 – 1) mm
- Double crimped wire leads, lead-free tinned
- Straight wire leads, lead-free tinned, lead length (17 ±3) mm
- Different lead spacings (reduced and enlarged) available, lead length (6 – 1) mm

Marking

Manufacturer's logo, style and type (P61x), rated capacitance (coded), capacitance tolerance (code letter), rated DC voltage, date of manufacture (code)

Delivery mode

Bulk (untaped)

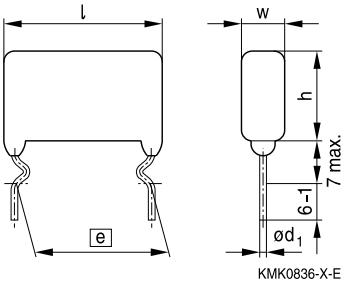
Taped (Ammo pack or reel)

For notes on taping, refer to chapter "Taping and packing".

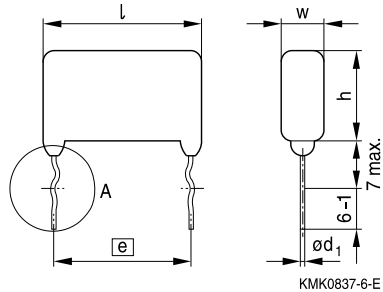


Dimensional drawings

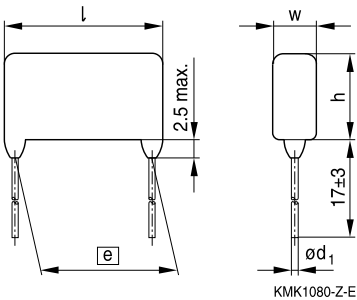
Crimped leads



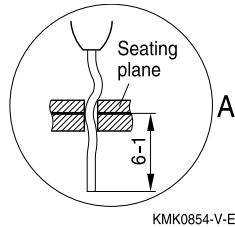
Double crimped leads



Straight leads

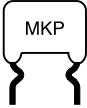


Detail of double crimped version



Dimensions in mm

Lead spacing	Lead diameter	Type
$e \pm 0.8$	d_1	
15.0	0.8	B32612
22.5	0.8	B32613
27.5	0.8	B32614








B32612 ... B32614

High pulse (wound)

Overview of available types

Lead spacing	15.0 mm							
Type	B32612							
Page	7							
V_R (V DC)	250	400	630	1000	1250	1600	1600	2000
V_{RMS} (V AC)	160	200	250	250	500	500	700	700
C_R (nF)								
1.0								
1.5								
2.2								
3.3								
4.7								
6.8								
10								
15								
22								
33								
47								
68								
100								
150								
220								
330								
470								
680								






Lead configurations

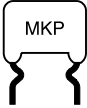
Serie	Standard	Reduced	Enlarged	Straight	Double crimped
					
B32612	15 mm	7.5 / 10 / 12.5 mm	17.5 mm	15 mm	15 mm
B32613	22.5 mm	15 / 17.5 / 20 mm	25 mm	22.5 mm	22.5 mm
B32614	27.5 mm	25 mm	–	27.5 mm	27.5 mm

Overview of available types

Lead spacing	22.5 mm						
Type	B32613						
Page	9						
V_R (V DC)	250	400	630	1000	1600	2000	2000
V_{RMS} (V AC)	160	200	250	250	500	700	1000
C_R (nF)							
3.3							
4.7							
6.8							
10							
15							
22							
33							
47							
68							
100							
150							
220							
330							
470							
680							
1000							

Lead configurations

Serie	Standard	Reduced	Enlarged	Straight	Double crimped
					
B32612	15 mm	7.5 / 10 / 12.5 mm	17.5 mm	15 mm	15 mm
B32613	22.5 mm	15 / 17.5 / 20 mm	25 mm	22.5 mm	22.5 mm
B32614	27.5 mm	25 mm	—	27.5 mm	27.5 mm








B32612 ... B32614

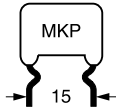
High pulse (wound)

Overview of available types

Lead spacing	27.5 mm					
Type	B32614					
Page	11					
V _R (V DC)	250	400	630	1000	1600	2000
V _{RMS} (V AC)	160	200	250	250	500	700
C _R (nF)						
10						
15						
22						
33						
47						
68						
100						
150						
220						
470						
680						
1000						
1500						
2200						

Lead configurations

Serie	Standard	Reduced	Enlarged	Straight	Double crimped
					
B32612	15 mm	7.5 / 10 / 12.5 mm	17.5 mm	15 mm	15 mm
B32613	22.5 mm	15 / 17.5 / 20 mm	25 mm	22.5 mm	22.5 mm
B32614	27.5 mm	25 mm	–	27.5 mm	27.5 mm


Ordering codes and packing units (lead spacing 15 mm)

V_R	V_{RMS} $f \leq 1$ kHz	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
V DC	V AC	nF					
250	160	150	6.5 × 12.5 × 18.0	B32612A3154+***	3400	4400	4000
		220	7.0 × 13.5 × 18.0	B32612A3224+***	3200	4000	4000
		330	8.0 × 14.5 × 18.0	B32612A3334+***	2800	3600	2000
		470	9.5 × 16.0 × 18.0	B32612A3474+***	2400	3200	2000
		680	11.5 × 17.5 × 18.0	B32612A3684+***	2000	2600	2000
400	200	68	6.5 × 12.0 × 18.0	B32612A4683+***	3400	4400	4000
		100	7.0 × 12.5 × 18.0	B32612A4104+***	3200	4000	4000
		150	7.5 × 12.5 × 18.0	B32612A4154+***	3000	4000	4000
		220	8.0 × 14.5 × 18.0	B32612A4224+***	2800	3600	2000
		330	9.5 × 16.0 × 18.0	B32612A4334+***	2400	3200	2000
		470	11.0 × 17.5 × 18.0	B32612A4474+***	2000	2600	2000
630	250	68	6.5 × 12.0 × 18.0	B32612A6683+***	3400	4400	4000
		100	7.5 × 13.0 × 18.0	B32612A6104+***	3000	4000	4000
		150	9.0 × 14.5 × 18.0	B32612A6154+***	2400	3200	2000
		220	10.0 × 16.5 × 18.0	B32612A6224+***	2200	3000	2000
1000	250	10	7.0 × 12.5 × 18.0	B32612A0103+***	3200	4000	4000
		15	8.0 × 13.5 × 18.0	B32612A0153+***	2800	3600	4000
		22	9.0 × 15.5 × 18.0	B32612A0223+***	2400	3200	4000
		33	6.5 × 13.0 × 18.0	B32612A0333+***	3400	4400	4000
		47	7.0 × 15.5 × 18.0	B32612A0473+***	3200	4000	4000
		68	8.5 × 16.5 × 18.0	B32612A0683+***	2600	3400	2000
		100	11.0 × 17.5 × 18.0	B32612A0104+***	2000	2600	2000

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = ±10%

J = ±5%

*** = Packaging code:

289 = Ammo pack

189 = Reel

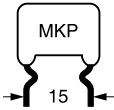
010 = Untaped crimped (lead length 6 – 1 mm)

008 = Untaped straight (lead length 17±3 mm)

020 = Double crimped (lead length 6 – 1 mm)

Packaging codes for further lead configurations (untaped):

Lead configuration (lead length 6 – 1 mm)	Reduced	Reduced	Reduced	Enlarged
Lead spacing (mm)	7.5 mm	10 mm	12.5 mm	17.5 mm
Packaging code	030	040	050	060


B32612
High pulse (wound)
Ordering codes and packing units (lead spacing 15 mm)

V_R	V_{RMS} $f \leq 1$ kHz	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
V DC	V AC	nF					
1250	500	6.8	7.0 × 11.0 × 18.0	B32612A7682+***	3200	4000	4000
		10	7.5 × 13.0 × 18.0	B32612A7103+***	3000	4000	4000
		15	8.0 × 14.0 × 18.0	B32612A7153+***	2800	3600	2000
		22	9.5 × 15.5 × 18.0	B32612A7223+***	2400	3200	2000
		33	11.0 × 17.5 × 18.0	B32612A7333+***	2000	2600	2000
1600	500	4.7	6.5 × 12.0 × 18.0	B32612A1472+***	3400	4400	4000
		6.8	8.0 × 13.0 × 18.0	B32612A1682+***	2800	3600	2000
		10	9.0 × 14.5 × 18.0	B32612A1103+***	2400	3200	2000
		15	10.0 × 17.5 × 18.0	B32612A1153+***	2200	3000	2000
1600	700	3.3	6.5 × 11.5 × 18.0	B32612J1332+***	3400	4400	4000
		4.7	7.5 × 12.5 × 18.0	B32612J1472+***	3000	4000	4000
		6.8	8.5 × 14.5 × 18.0	B32612J1682+***	2600	3400	2000
		10	9.5 × 17.0 × 18.0	B32612J1103+***	2400	3200	1000
2000	700	1.0	7.0 × 10.5 × 18.0	B32612A2102+***	3200	4000	4000
		1.5	7.5 × 11.5 × 18.0	B32612A2152+***	3000	4000	4000
		2.2	8.0 × 14.5 × 18.0	B32612A2222+***	2800	3600	4000
		3.3	8.5 × 15.0 × 18.0	B32612A2332+***	2600	3400	2000
		4.7	9.5 × 18.0 × 18.0	B32612A2472+***	2400	3200	2000

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = ±10%

J = ±5%

*** = Packaging code:

289 = Ammo pack

189 = Reel

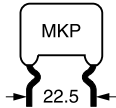
010 = Untaped crimped (lead length 6 – 1 mm)

008 = Untaped straight (lead length 17±3 mm)

020 = Double crimped (lead length 6 – 1 mm)

Packaging codes for further lead configurations (untaped):

Lead configuration (lead length 6 – 1 mm)	Reduced	Reduced	Reduced	Enlarged
Lead spacing (mm)	7.5 mm	10 mm	12.5 mm	17.5 mm
Packaging code	030	040	050	060


Ordering codes and packing units (lead spacing 22.5 mm)

V_R	V_{RMS} $f \leq 1$ kHz	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
V DC	V AC	nF					
250	160	220	$7.0 \times 14.5 \times 26.5$	B32613A3224+***	2000	2800	2000
		330	$7.0 \times 14.5 \times 26.5$	B32613A3334+***	2000	2800	2000
		470	$8.0 \times 15.5 \times 26.5$	B32613A3474+***	1800	2400	2000
		680	$9.5 \times 16.0 \times 26.5$	B32613A3684+***	1400	2000	2000
		1000	$11.0 \times 19.0 \times 26.5$	B32613A3105+***	1200	1800	1000
400	200	150	$7.0 \times 13.5 \times 26.5$	B32613A4154+***	2000	2800	2000
		220	$7.0 \times 14.0 \times 26.5$	B32613A4224+***	2000	2800	2000
		330	$8.0 \times 16.0 \times 26.5$	B32613A4334+***	1800	2400	2000
		470	$9.5 \times 16.0 \times 26.5$	B32613A4474+***	1400	2000	1000
		680	$11.5 \times 17.5 \times 26.5$	B32613A4684+***	1200	1600	1000
630	250	100	$7.0 \times 12.5 \times 26.5$	B32613A6104+***	2000	2800	1000
		150	$7.5 \times 14.0 \times 26.5$	B32613A6154+***	1800	2600	1000
		220	$9.0 \times 15.5 \times 26.5$	B32613A6224+***	1600	2200	1000
		330	$10.0 \times 18.0 \times 26.5$	B32613A6334+***	1400	2000	1000
		470	$11.0 \times 20.0 \times 26.5$	B32613A6474+***	1200	1800	1000
1000	250	33	$8.5 \times 14.5 \times 26.5$	B32613A0333+***	1600	2200	2000
		47	$10.0 \times 15.5 \times 26.5$	B32613A0473+***	1400	2000	1000
		68	$11.0 \times 17.5 \times 26.5$	B32613A0683+***	1200	1800	1000
		100	$10.0 \times 16.5 \times 26.5$	B32613A0104+***	1400	2000	1000
		150	$12.0 \times 18.0 \times 26.5$	B32613A0154+***	1200	1600	1000

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$

J = $\pm 5\%$

*** = Packaging code:

289 = Ammo pack

189 = Reel

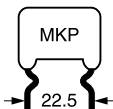
010 = Untaped crimped (lead length 6 – 1 mm)

008 = Untaped straight (lead length 17 ± 3 mm)

020 = Double crimped (lead length 6 – 1 mm)

Packaging codes for further lead configurations (untaped):

Lead configuration (lead length 6 – 1 mm)	Reduced	Reduced	Reduced	Enlarged
Lead spacing (mm)	15 mm	17.5 mm	20 mm	25 mm
Packaging code	055	060	070	080


B32613
High pulse (wound)
Ordering codes and packing units (lead spacing 22.5 mm)

V_R	V_{RMS} $f \leq 1$ kHz	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Ammo pack pcs./MOQ	Reel pcs./ MOQ	Untaped pcs./ MOQ
V DC	V AC	nF					
1600	500	10	$7.0 \times 13.5 \times 26.5$	B32613A1103+***	2000	2800	2000
		15	$8.0 \times 14.5 \times 26.5$	B32613A1153+***	1800	2400	2000
		22	$9.0 \times 17.0 \times 26.5$	B32613A1223+***	1600	2200	1000
		33	$10.5 \times 18.5 \times 26.5$	B32613A1333+***	1400	1800	1000
2000	700	3.3	$7.0 \times 13.0 \times 26.5$	B32613A2332+***	2000	2800	2000
		4.7	$7.5 \times 14.0 \times 26.5$	B32613A2472+***	1800	2600	2000
		6.8	$8.5 \times 16.0 \times 26.5$	B32613A2682+***	1600	2200	2000
		10	$10.5 \times 17.0 \times 26.5$	B32613A2103+***	1400	1800	1000
		15	$12.0 \times 20.5 \times 26.5$	B32613A2153+***	1200	1600	1000
2000	1000	3.3	$8.0 \times 14.5 \times 26.5$	B32613A8332+***	1800	2400	2000
		4.7	$8.5 \times 16.5 \times 26.5$	B32613A8472+***	1600	2200	1000
		6.8	$10.0 \times 18.5 \times 26.5$	B32613A8682+***	1400	2000	1000
		10	$11.5 \times 21.5 \times 26.5$	B32613A8103+***	1200	1600	1000

MOQ = Minimum Order Quantity, consisting of 4 packing units.

Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = $\pm 10\%$

J = $\pm 5\%$

*** = Packaging code:

289 = Ammo pack

189 = Reel

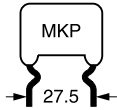
010 = Untaped crimped (lead length 6 – 1 mm)

008 = Untaped straight (lead length 17 \pm 3 mm)

020 = Double crimped (lead length 6 – 1 mm)

Packing codes for further lead configurations (untaped):

Lead configuration (lead length 6 – 1 mm)	Reduced	Reduced	Reduced	Enlarged
Lead spacing (mm)	15 mm	17.5 mm	20 mm	25 mm
Packing code	055	060	070	080


Ordering codes and packing units (lead spacing 27.5 mm)

V_R	V_{RMS} $f \leq 1 \text{ kHz}$	C_R	Max. dimensions $w \times h \times l$ mm	Ordering code (composition see below)	Untaped pcs./MOQ
V DC	V AC	nF			
250	160	470	7.0 × 15.0 × 31.5	B32614A3474+***	2000
		680	8.0 × 16.5 × 31.5	B32614A3684+***	2000
		1000	9.5 × 17.5 × 31.5	B32614A3105+***	800
		1500	11.5 × 19.5 × 31.5	B32614A3155+***	800
		2200	14.0 × 22.0 × 31.5	B32614A3225+***	800
400	200	470	9.5 × 15.0 × 31.5	B32614A4474+***	800
		680	10.0 × 17.5 × 31.5	B32614A4684+***	800
		1000	11.5 × 19.5 × 31.5	B32614A4105+***	800
		1500	14.0 × 22.0 × 31.5	B32614A4155+***	800
		2200	16.5 × 24.5 × 31.5	B32614A4225+***	600
630	250	470	10.5 × 18.5 × 31.5	B32614A6474+***	800
		680	12.0 × 21.5 × 31.5	B32614A6684+***	800
		1000	14.0 × 24.0 × 31.5	B32614A6105+***	800
1000	250	100	11.5 × 17.5 × 31.5	B32614A0104+***	2000
		150	13.0 × 21.0 × 31.5	B32614A0154+***	800
		220	14.5 × 24.5 × 31.5	B32614A0224+***	800
1600	500	22	9.0 × 14.5 × 31.5	B32614A1223+***	2000
		33	10.5 × 16.0 × 31.5	B32614A1333+***	2000
		47	11.0 × 19.5 × 31.5	B32614A1473+***	800
		68	13.0 × 21.5 × 31.5	B32614A1683+***	800
2000	700	10	9.0 × 15.5 × 31.5	B32614A2103+***	2000
		15	11.0 × 17.5 × 31.5	B32614A2153+***	800
		22	13.0 × 19.5 × 31.5	B32614A2223+***	800
		33	14.5 × 23.0 × 31.5	B32614A2333+***	800
		47	16.5 × 25.5 × 31.5	B32614A2473+***	600

MOQ = Minimum Order Quantity, consisting of 4 packing units.
Further E series and intermediate capacitance values on request.

Composition of ordering code

+ = Capacitance tolerance code:

K = ±10%

J = ±5%

*** = Packaging code:

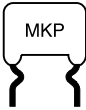
010 = Untaped crimped (lead length 6 – 1 mm)

008 = Untaped straight (lead length 17±3 mm)

020 = Double crimped (lead length 6 – 1 mm)

Packaging codes for further lead configurations (untaped):

Lead configuration (lead length 6 – 1 mm)	Reduced
Lead spacing (mm)	25 mm
Packaging code	090

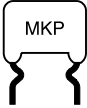

Technical data

Operating temperature range	Max. operating temperature $T_{op,max}$			+110 °C
	Upper category temperature T_{max}			+100 °C
	Lower category temperature T_{min}			-55 °C
	Rated temperature T_R			+85 °C
Dissipation factor $\tan \delta$ (in 10^{-3}) at 20 °C (upper limit values)	at	$C_R \leq 0.1 \mu F$	$0.1 \mu F < C_R \leq 1 \mu F$	$C_R > 1 \mu F$
	1 kHz	–	0.5	0.5
	10 kHz	–	0.8	1.5
	100 kHz	5.0	–	–
Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$ at 20 °C, rel. humidity $\leq 65\%$ (minimum as-delivered values)	$C_R \leq 0.33 \mu F$		$C_R > 0.33 \mu F$	
	100 G Ω		30000 s	
DC test voltage	1.6 · V_R , 2 s			
Category voltage V_C (continuous operation with V_{DC} or V_{AC} at $f \leq 1$ kHz)	T_A (°C)	DC voltage derating	AC voltage derating	
	$T_A \leq 85$ $85 < T_A \leq 100$	$V_C = V_R$ $V_C = V_R \cdot (165 - T_A) / 80$	$V_{C,RMS} = V_{RMS}$ $V_{C,RMS} = V_{RMS} \cdot (165 - T_A) / 80$	
Operating voltage V_{op} for short operating periods (V_{DC} or V_{AC} at $f \leq 1$ kHz)	T_A (°C)	DC voltage (max. hours)	AC voltage (max. hours)	
	$T_A \leq 100$ $100 < T_A \leq 110$	$V_{op} = 1.25 \cdot V_C$ (2000 h) $V_{op} = 1.25 \cdot V_C$ (1000 h)	$V_{op} = 1.0 \cdot V_{C,RMS}$ (2000 h) $V_{op} = 1.0 \cdot V_{C,RMS}$ (1000 h)	
Damp heat test Limit values after damp heat test	56 days/40 °C/93% relative humidity			
	Capacitance change $ \Delta C/C $		$\leq 3\%$	
	Dissipation factor change $\Delta \tan \delta$		$\leq 0.5 \cdot 10^{-3}$ (at 1 kHz) $\leq 1.0 \cdot 10^{-3}$ (at 10 kHz)	
	Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$		$\geq 50\%$ of minimum as-delivered values	
Reliability: Failure rate λ Service life t_{SL}	1 fit ($\leq 1 \cdot 10^{-9}$ /h) at 0.5 · V_R , 40 °C 200 000 h at 1.0 · V_R , 85 °C For conversion to other operating conditions and temperatures, refer to chapter "Quality, 2 Reliability".			
Failure criteria: Total failure Failure due to variation of parameters	Short circuit or open circuit			
	Capacitance change $ \Delta C/C $		$> 10\%$	
	Dissipation factor $\tan \delta$		$> 4 \cdot$ upper limit value	
	Insulation resistance R_{ins} or time constant $\tau = C_R \cdot R_{ins}$		< 1500 M Ω ($C_R \leq 0.33 \mu F$) < 500 s ($C_R > 0.33 \mu F$)	



Characteristic voltages V_{DC} , V_{AC} , V_{pp}

V_{DC} V	V_{AC} V	V_{pp} V
1000	250	700
1250	500	1250
1600	500	1400
1600	700	1600
2000	700	1600
2000	1000	2000



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High pulse (wound)

Pulse handling capability

"dV/dt" represents the maximum permissible voltage change per unit of time for non-sinusoidal voltages, expressed in V/ μ s.

"k₀" represents the maximum permissible pulse characteristic of the waveform applied to the capacitor, expressed in V²/ μ s.

Note:

The values of dV/dt and k₀ provided below must not be exceeded in order to avoid damaging the capacitor.

dV/dt values

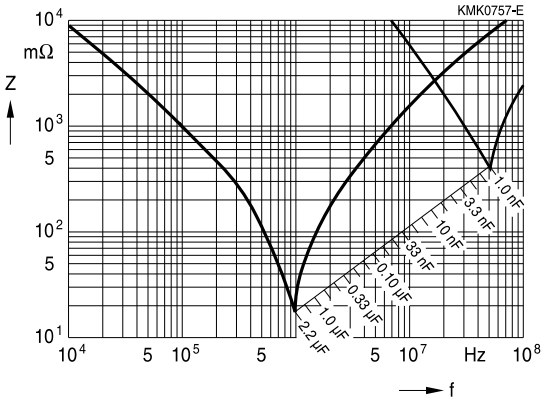
Lead spacing		15 mm	22.5 mm	27.5 mm
V _R V DC	V _{RMS} V AC	dV/dt in V/ μ s		
250	160	200	120	50
400	200	300	180	100
630	250	400	300	150
1000	250	975	600	300
1250	500	1850	1150	600
1600	500	4500	2400	1000
1600	700	5200	–	–
2000	700	8000	7000	2300
2000	1000	–	7500	–

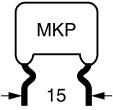
k₀ values

Lead spacing		15 mm	22.5 mm	27.5 mm
V _R V DC	V _{RMS} V AC	k ₀ in V ² / μ s		
250	160	100 000	60 000	25 000
400	200	250 000	200 000	110 000
630	250	500 000	350 000	250 000
1000	250	3 000 000	1 500 000	1 000 000
1250	500	9 000 000	3 750 000	2 000 000
1600	500	20 000 000	10 000 000	4 000 000
1600	700	28 000 000	–	–
2000	700	60 000 000	40 000 000	15 000 000
2000	1000	–	50 000 000	–



Impedance Z versus frequency f
(typical values)





B32612

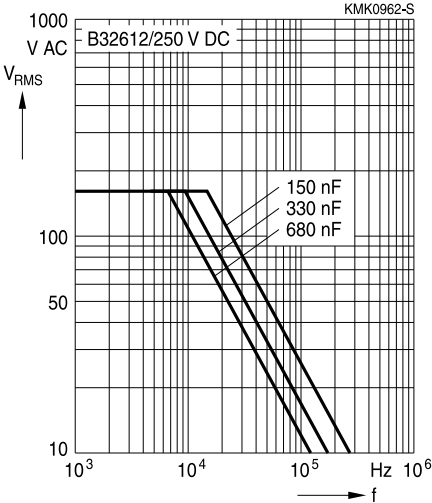
High pulse (wound)

Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)

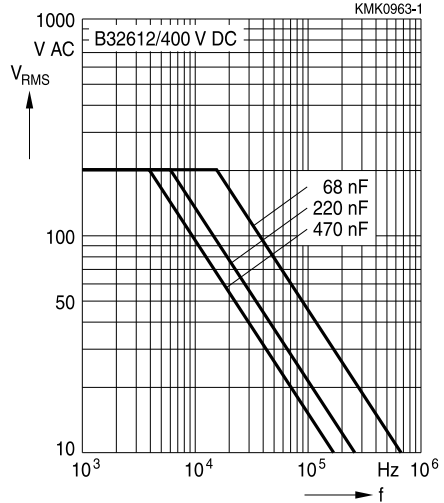
For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 15 mm

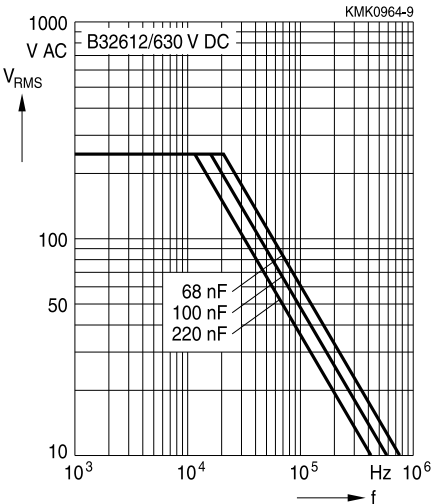
250 V DC/160 V AC



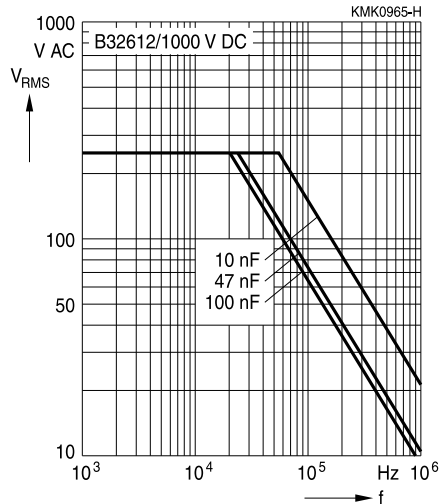
400 V DC/200 V AC

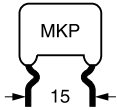


630 V DC/250 V AC



1000 V DC/250 V AC



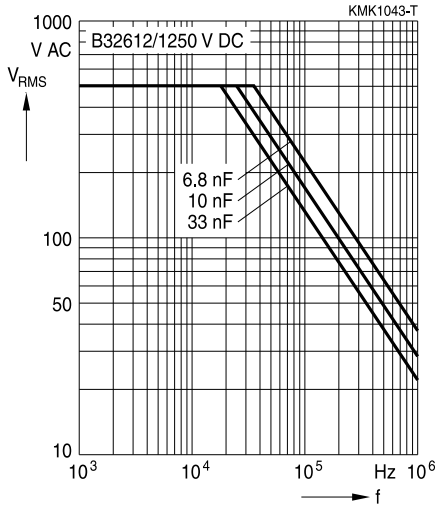


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)

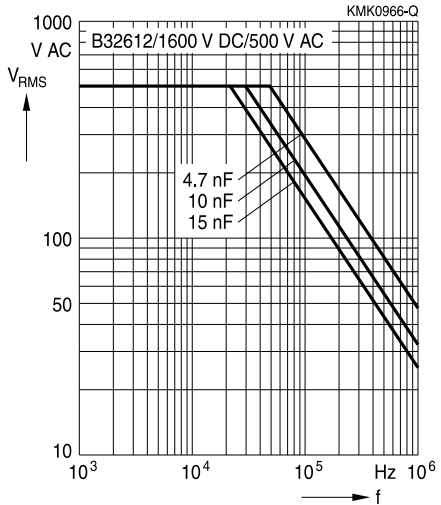
For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 15 mm

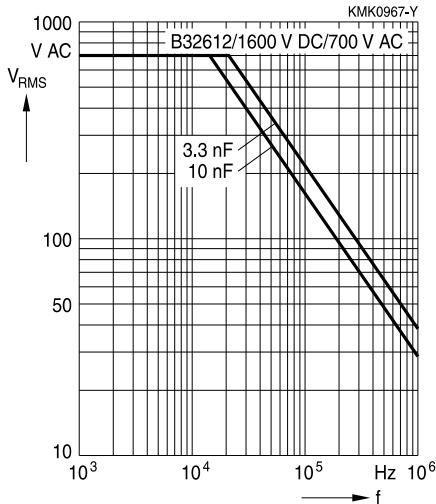
1250 V DC/500 V AC



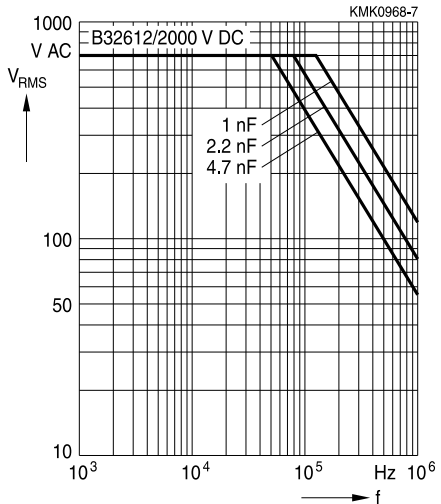
1600 V DC/500 V AC

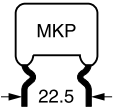


1600 V DC/700 V AC



2000 V DC/700 V AC





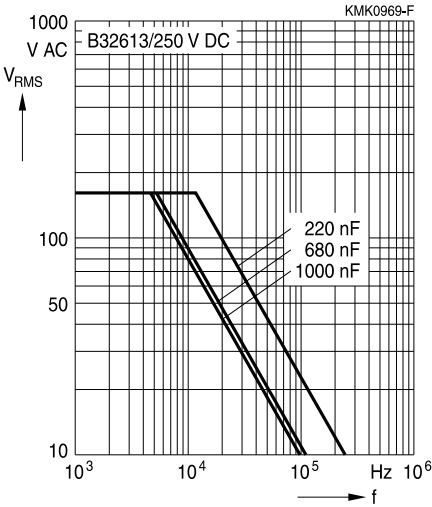
B32613

High pulse (wound)

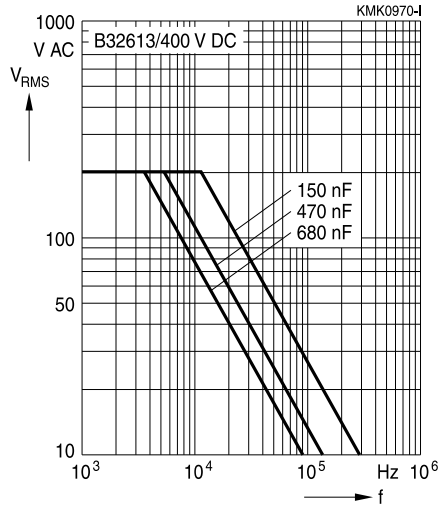
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)
 For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 22.5 mm

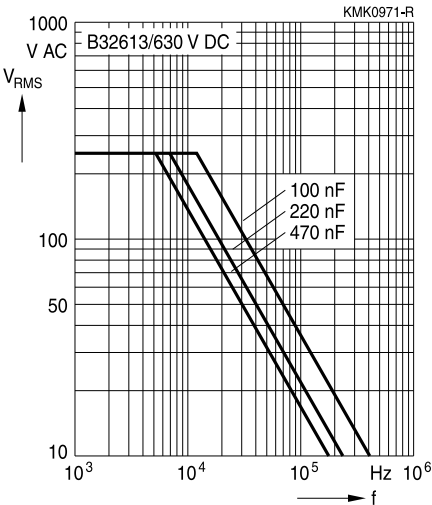
250 V DC/160 V AC



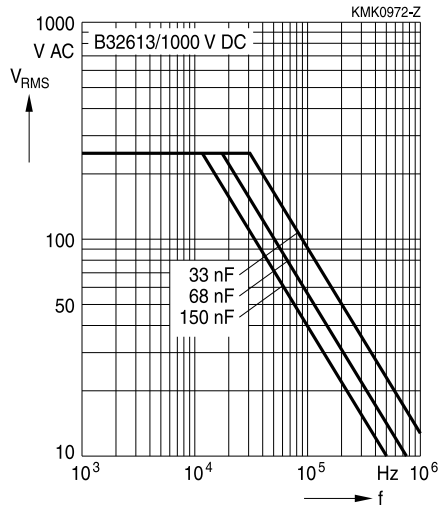
400 V DC/200 V AC

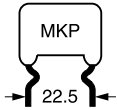


630 V DC/250 V AC



1000 V DC/250 V AC



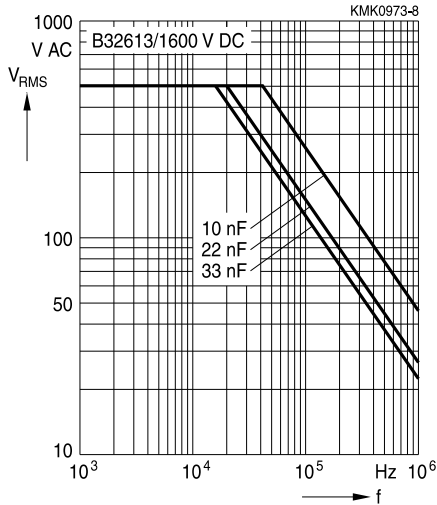


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)

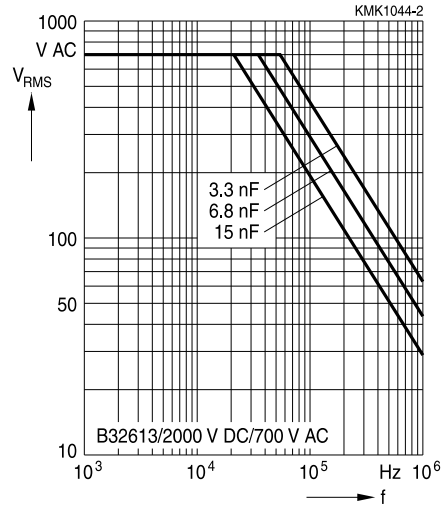
For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 22.5 mm

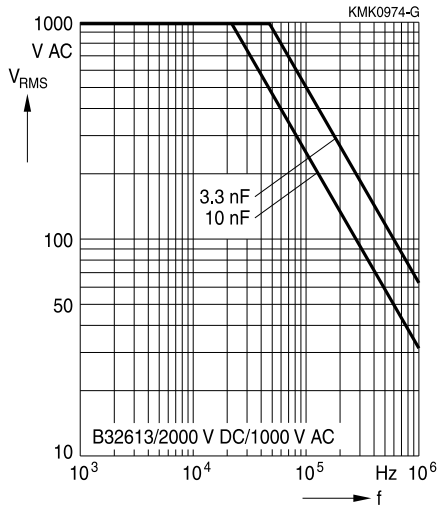
1600 V DC/500 V AC

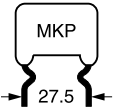


2000 V DC/700 V AC



2000 V DC/1000 V AC





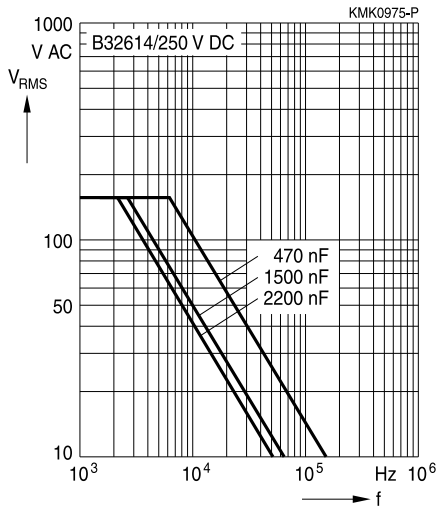
B32614

High pulse (wound)

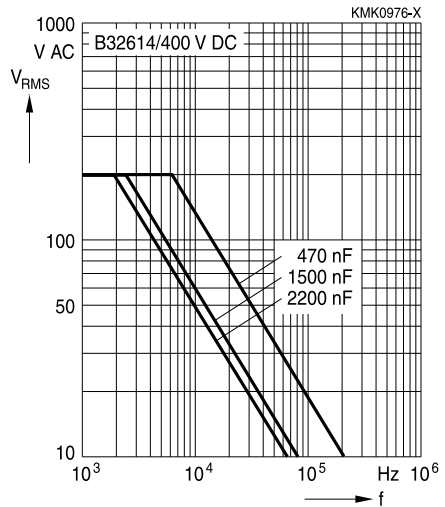
Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)
 For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

Lead spacing 27.5 mm

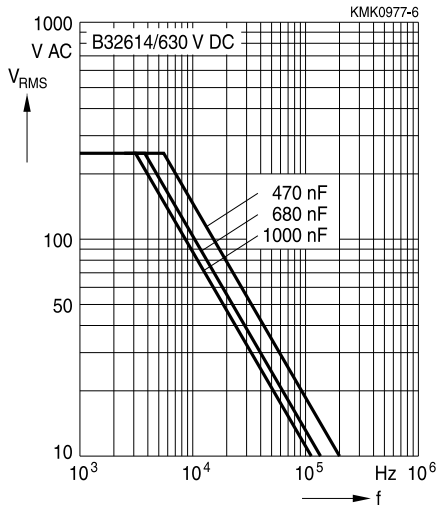
250 V DC/160 V AC



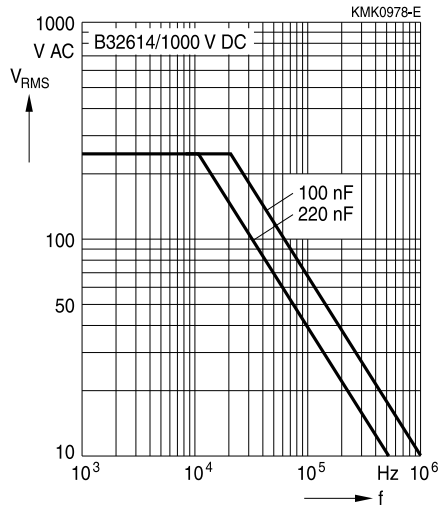
400 V DC/200 V AC

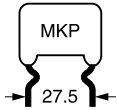


630 V DC/250 V AC



1000 V DC/250 V AC



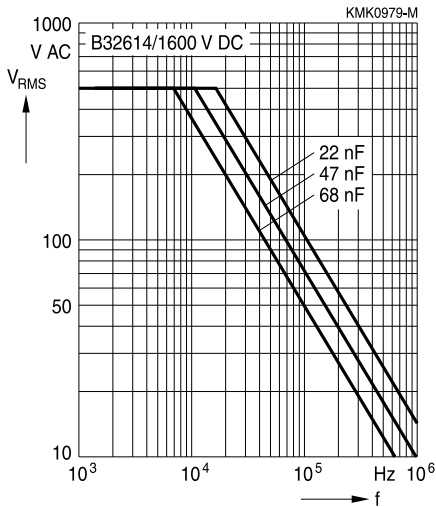


Permissible AC voltage V_{RMS} versus frequency f (for sinusoidal waveforms, $T_A \leq 90^\circ C$)

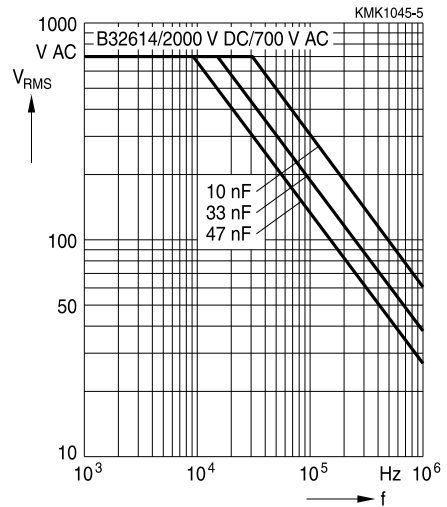
For $T_A > 90^\circ C$, please refer to "General technical information", section 3.2.3.

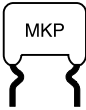
Lead spacing 27.5 mm

1600 V DC/500 V AC



2000 V DC/700 V AC





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High pulse (wound)

Mounting guidelines

1 Soldering

1.1 Solderability of leads

The solderability of terminal leads is tested to IEC 60068-2-20, test Ta, method 1.

Before a solderability test is carried out, terminals are subjected to accelerated ageing (to IEC 60068-2-2, test Ba: 4 h exposure to dry heat at 155 °C). Since the ageing temperature is far higher than the upper category temperature of the capacitors, the terminal wires should be cut off from the capacitor before the ageing procedure to prevent the solderability being impaired by the products of any capacitor decomposition that might occur.

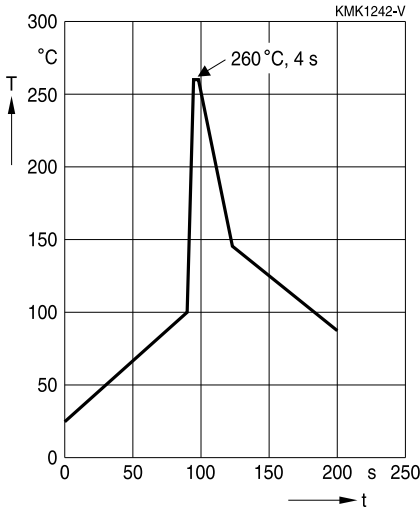
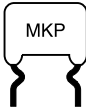
Solder bath temperature	235 ±5 °C
Soldering time	2.0 ±0.5 s
Immersion depth	2.0 +0/-0.5 mm from capacitor body or seating plane
Evaluation criteria: Visual inspection	Wetting of wire surface by new solder ≥90%, free-flowing solder

1.2 Resistance to soldering heat

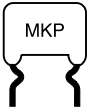
Resistance to soldering heat is tested to IEC 60068-2-20, test Tb, method 1A.

Conditions:

Series	Solder bath temperature	Soldering time
MKT boxed (except 2.5 × 6.5 × 7.2 mm) coated uncoated (lead spacing > 10 mm)	260 ±5 °C	10 ±1 s
MFP MKP (lead spacing > 7.5 mm)		
MKT boxed (case 2.5 × 6.5 × 7.2 mm)		5 ±1 s
MKP (lead spacing ≤ 7.5 mm) MKT uncoated (lead spacing ≤ 10 mm) insulated (B32559)		< 4 s recommended soldering profile for MKT uncoated (lead spacing ≤ 10 mm) and insulated (B32559)



Immersion depth	2.0 +0/−0.5 mm from capacitor body or seating plane
Shield	Heat-absorbing board, (1.5 ±0.5) mm thick, between capacitor body and liquid solder
Evaluation criteria:	
Visual inspection	No visible damage
$\Delta C/C_0$	2% for MKT/MKP/MFP 5% for EMI suppression capacitors
$\tan \delta$	As specified in sectional specification



1.3 General notes on soldering

Permissible heat exposure loads on film capacitors are primarily characterized by the upper category temperature T_{max} . Long exposure to temperatures above this type-related temperature limit can lead to changes in the plastic dielectric and thus change irreversibly a capacitor's electrical characteristics. For short exposures (as in practical soldering processes) the heat load (and thus the possible effects on a capacitor) will also depend on other factors like:

- Pre-heating temperature and time
- Forced cooling immediately after soldering
- Terminal characteristics:
 - diameter, length, thermal resistance, special configurations (e.g. crimping)
- Height of capacitor above solder bath
- Shadowing by neighboring components
- Additional heating due to heat dissipation by neighboring components
- Use of solder-resist coatings

The overheating associated with some of these factors can usually be reduced by suitable countermeasures. For example, if a pre-heating step cannot be avoided, an additional or reinforced cooling process may possibly have to be included.

EPCOS recommends the following conditions:

- Pre-heating with a maximum temperature of 110 °C
- Temperature inside the capacitor should not exceed the following limits:
 - MKP/MFP 110 °C
 - MKT 160 °C
- When SMD components are used together with leaded ones, the leaded film capacitors should not pass into the SMD adhesive curing oven. The leaded components should be assembled after the SMD curing step.
- Leaded film capacitors are not suitable for reflow soldering.

Uncoated capacitors

For uncoated MKT capacitors with lead spacings ≤ 10 mm (B32560/B32561) the following measures are recommended:

- pre-heating to not more than 110 °C in the preheater phase
- rapid cooling after soldering



2 Cleaning

To determine whether the following solvents, often used to remove flux residues and other substances, are suitable for the capacitors described, refer to the table below:

Type	Ethanol, isopropanol, n-propanol	n-propanol-water mixtures, water with surface tension-reducing tensides (neutral)	Solvent from table A (see next page)	Solvent from table B (see next page)
MKT (uncoated)	Suitable	Unsuitable	In part suitable	Unsuitable
MKT, MKP, MFP (coated/boxed)		Suitable	Suitable	

Even when suitable solvents are used, a reversible change of the electrical characteristics may occur in uncoated capacitors immediately after they are washed. Thus it is always recommended to dry the components (e.g. 4 h at 70 °C) before they are subjected to subsequent electrical testing.

Table A

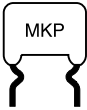
Manufacturers' designations for trifluoro-trichloro-ethane-based cleaning solvents (selection)

Trifluoro-trichloro-ethane	Mixtures of trifluoro-trichloro-ethane with ethanol and isopropanol	Manufacturer
Freon TF	Freon TE 35; Freon TP 35; Freon TES	Du Pont
Frigen 113 TR	Frigen 113 TR-E; Frigen 113 TR-P; Frigen TR-E 35	Hoechst
Arklone P	Arklone A; Arklone L; Arklone K	ICI
Kaltron 113 MDR	Kaltron 113 MDA; Kaltron 113 MDI; Kaltron 113 MDI 35	Kali-Chemie
Flugene 113	Flugene 113 E; Flugene 113 IPA	Rhone-Progil

Table B (worldwide banned substances)

Manufacturers' designations for unsuitable cleaning solvents (selection)

Mixtures of chlorinated hydrocarbons and ketones with fluorated hydrocarbons	Manufacturer
Freon TMC; Freon TA; Freon TC	Du Pont
Arklone E	ICI
Kaltron 113 MDD; Kaltron 113 MDK	Kali-Chemie
Flugene 113 CM	Rhone-Progil



B32612 ... B32614

High pulse (wound)

3 Embedding of capacitors in finished assemblies

In many applications, finished circuit assemblies are embedded in plastic resins. In this case, both chemical and thermal influences of the embedding ("potting") and curing processes must be taken into account.

Our experience has shown that the following potting materials can be recommended: non-flexible epoxy resins with acid-anhydride hardeners; chemically inert, non-conducting fillers; maximum curing temperature of 100 °C.

Caution:

Consult us first if you wish to embed uncoated types!

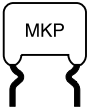


Cautions and warnings

- Do not exceed the upper category temperature (UCT).
- Do not apply any mechanical stress to the capacitor terminals.
- Avoid any compressive, tensile or flexural stress.
- Do not move the capacitor after it has been soldered to the PC board.
- Do not pick up the PC board by the soldered capacitor.
- Do not place the capacitor on a PC board whose PTH hole spacing differs from the specified lead spacing.
- Do not exceed the specified time or temperature limits during soldering.
- Avoid external energy inputs, such as fire or electricity.
- Avoid overload of the capacitors.

The table below summarizes the safety instructions that must always be observed. A detailed description can be found in the relevant sections of the chapters "General technical information" and "Mounting guidelines".

Topic	Safety information	Reference chapter "General technical information"
Storage conditions	Make sure that capacitors are stored within the specified range of time, temperature and humidity conditions.	4.5 "Storage conditions"
Flammability	Avoid external energy, such as fire or electricity (passive flammability), avoid overload of the capacitors (active flammability) and consider the flammability of materials.	5.3 "Flammability"
Resistance to vibration	Do not exceed the tested ability to withstand vibration. The capacitors are tested to IEC 60068-2-6. EPCOS offers film capacitors specially designed for operation under more severe vibration regimes such as those found in automotive applications. Consult our catalog "Film Capacitors for Automotive Electronics".	5.2 "Resistance to vibration"



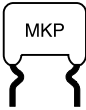
B32612 ... B32614

High pulse (wound)

Topic	Safety information	Reference chapter "Mounting guidelines"
Soldering	Do not exceed the specified time or temperature limits during soldering.	1 "Soldering"
Cleaning	Use only suitable solvents for cleaning capacitors.	2 "Cleaning"
Embedding of capacitors in finished assemblies	When embedding finished circuit assemblies in plastic resins, chemical and thermal influences must be taken into account. Caution: Consult us first, if you also wish to embed other uncoated component types!	3 "Embedding of capacitors in finished assemblies"

Symbols and terms

Symbol	English	German
α	Heat transfer coefficient	Wärmeübergangszahl
α_C	Temperature coefficient of capacitance	Temperaturkoeffizient der Kapazität
A	Capacitor surface area	Kondensatoroberfläche
β_C	Humidity coefficient of capacitance	Feuchtekoeffizient der Kapazität
C	Capacitance	Kapazität
C_R	Rated capacitance	Nennkapazität
ΔC	Absolute capacitance change	Absolute Kapazitätsänderung
$\Delta C/C$	Relative capacitance change (relative deviation of actual value)	Relative Kapazitätsänderung (relative Abweichung vom Ist-Wert)
$\Delta C/C_R$	Capacitance tolerance (relative deviation from rated capacitance)	Kapazitätstoleranz (relative Abweichung vom Nennwert)
dt	Time differential	Differentielle Zeit
Δt	Time interval	Zeitintervall
ΔT	Absolute temperature change (self-heating)	Absolute Temperaturänderung (Selbsterwärmung)
$\Delta \tan \delta$	Absolute change of dissipation factor	Absolute Änderung des Verlustfaktors
ΔV	Absolute voltage change	Absolute Spannungsänderung
dV/dt	Time differential of voltage function (rate of voltage rise)	Differentielle Spannungsänderung (Spannungsflankensteilheit)
$\Delta V/\Delta t$	Voltage change per time interval	Spannungsänderung pro Zeitintervall
E	Activation energy for diffusion	Aktivierungsenergie zur Diffusion
ESL	Self-inductance	Eigeninduktivität
ESR	Equivalent series resistance	Ersatz-Serienwiderstand
f	Frequency	Frequenz
f_1	Frequency limit for reducing permissible AC voltage due to thermal limits	Grenzfrequenz für thermisch bedingte Reduzierung der zulässigen Wechselspannung
f_2	Frequency limit for reducing permissible AC voltage due to current limit	Grenzfrequenz für strombedingte Reduzierung der zulässigen Wechselspannung
f_r	Resonant frequency	Resonanzfrequenz
F_D	Thermal acceleration factor for diffusion	Therm. Beschleunigungsfaktor zur Diffusion
F_T	Derating factor	Deratingfaktor
i	Current (peak)	Stromspitze
I_C	Category current (max. continuous current)	Kategoriestrom (max. Dauerstrom)



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High pulse (wound)

Symbol	English	German
I_{RMS}	(Sinusoidal) alternating current, root-mean-square value	(Sinusförmiger) Wechselstrom
i_z	Capacitance drift	Inkonstanz der Kapazität
k_0	Pulse characteristic	Impuls Kennwert
L_S	Series inductance	Serieninduktivität
λ	Failure rate	Ausfallrate
λ_0	Constant failure rate during useful service life	Konstante Ausfallrate in der Nutzungsphase
λ_{test}	Failure rate, determined by tests	Experimentell ermittelte Ausfallrate
P_{diss}	Dissipated power	Abgegebene Verlustleistung
P_{gen}	Generated power	Erzeugte Verlustleistung
Q	Heat energy	Wärmeenergie
ρ	Density of water vapor in air	Dichte von Wasserdampf in Luft
R	Universal molar constant for gases	Allg. Molarkonstante für Gas
R	Ohmic resistance of discharge circuit	Ohmscher Widerstand des Entladekreises
R_i	Internal resistance	Innenwiderstand
R_{ins}	Insulation resistance	Isolationswiderstand
R_P	Parallel resistance	Parallelwiderstand
R_S	Series resistance	Serienwiderstand
S	severity (humidity test)	Schärfegrad (Feuchtetest)
t	Time	Zeit
T	Temperature	Temperatur
τ	Time constant	Zeitkonstante
$\tan \delta$	Dissipation factor	Verlustfaktor
$\tan \delta_D$	Dielectric component of dissipation factor	Dielektrischer Anteil des Verlustfaktors
$\tan \delta_P$	Parallel component of dissipation factor	Parallelanteil des Verlustfaktors
$\tan \delta_S$	Series component of dissipation factor	Serienanteil des Verlustfaktors
T_A	Ambient temperature	Umgebungstemperatur
T_{max}	Upper category temperature	Obere Kategorietemperatur
T_{min}	Lower category temperature	Untere Kategorietemperatur
t_{OL}	Operating life at operating temperature and voltage	Betriebszeit bei Betriebstemperatur und -spannung
T_{op}	Operating temperature	Betriebstemperatur
T_R	Rated temperature	Nenntemperatur
T_{ref}	Reference temperature	Referenztemperatur
t_{SL}	Reference service life	Referenz-Lebensdauer
V_{AC}	AC voltage	Wechselspannung

Symbol	English	German
V_C	Category voltage	Kategoriespannung
$V_{C,RMS}$	Category AC voltage	(Sinusförmige) Kategorie-Wechselspannung
V_{CD}	Corona-discharge onset voltage	Teilentlade-Einsatzspannung
V_{ch}	Charging voltage	Ladespannung
V_{DC}	DC voltage	Gleichspannung
V_{FB}	Fly-back capacitor voltage	Spannung (Flyback)
V_i	Input voltage	Eingangsspannung
V_o	Output voltage	Ausgangssspannung
V_{op}	Operating voltage	Betriebsspannung
V_p	Peak pulse voltage	Impuls-Spitzenspannung
V_{pp}	Peak-to-peak voltage Impedance	Spannungshub
V_R	Rated voltage	Nennspannung
\hat{V}_R	Amplitude of rated AC voltage	Amplitude der Nenn-Wechselspannung
V_{RMS}	(Sinusoidal) alternating voltage, root-mean-square value	(Sinusförmige) Wechselspannung
V_{SC}	S-correction voltage	Spannung bei Anwendung "S-correction"
V_{sn}	Snubber capacitor voltage	Spannung bei Anwendung "Beschaltung"
Z	Impedance	Scheinwiderstand
e	Lead spacing	Rastermaß

Important notes

The following applies to all products named in this publication:

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